

date 03/01/2024

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MODEL: HSB35-272725 | DESCRIPTION: HEAT SINK

FEATURES

- BGA design
- aluminum alloy
- · black anodized finish





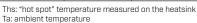
thermal resistance¹ power **MODEL** dissipation¹ @ 75°C ∆T, nat @ 1 W, @ 1 W, @ 1 W, @ 75°C ∆T, nat 400 LFM conv (°C/W) nat conv 200 LFM conv (°C/W) $(^{\circ}C/W)$ (°C/W) (W) 8.74 12.1 2.9 1.9 8.59 HSB35-272725

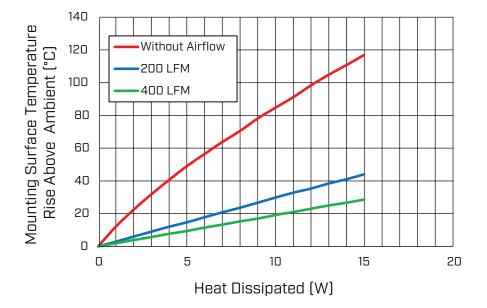
Note:

1. See performance curves for full thermal resistance details.

PERFORMANCE CURVES

	Heatsink Temperature Rise Above Ambient (ΔT = Ths - Ta) (°C)		
Power (W)	Natural Conv.	200 LFM	400 LFM
0	0	0	0
1	12.1	2.9	1.9
2	22.4	6.0	3.9
3	31.8	9.0	5.7
4	40.6	12.0	7.7
5	49.0	14.7	9.4
6	56.4	17.8	11.5
7	63.7	20.8	13.3
8	70.5	23.6	15.3
9	78.1	26.7	17.0
10	84.7	29.8	19.2
11	91.1	32.8	21.0
12	98.3	35.3	23.0
13	104.8	38.4	25.0
14	110.7	41.0	26.7
15	116.9	44.0	28.6



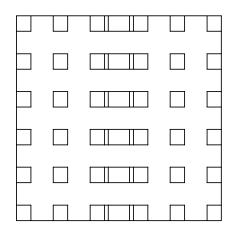


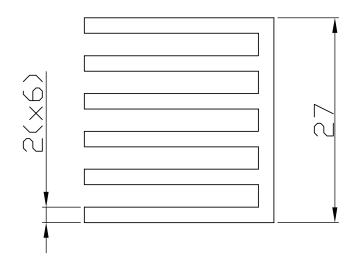
MECHANICAL DRAWING

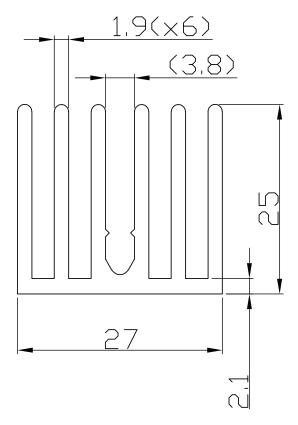
units: mm

tolerance: ±0.50 mm

MATERIAL	AL 6063-T5
FINISH	black anodized
WEIGHT	14 g







Additional Resources: Product Page

CUI DEVICES | MODEL: HSB35-272725 | DESCRIPTION: HEAT SINK

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REVISION HISTORY

rev.	description	date
1.0	initial release	03/01/2024

The revision history provided is for informational purposes only and is believed to be accurate.



CUI Devices offers a one (1) year limited warranty. Complete warranty information is listed on our website.

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